

DA2JF81

Silicon epitaxial planar type

For high speed switching circuits

■ Features

- Small reverse current I_R
- High repetitive peak reverse voltage V_{RRM}
- Contributes to miniaturization of sets, reduction of component count.
- Eco-friendly Halogen-free package

■ Packaging

Embossed type (Thermo-compression sealing): 3000 pcs / reel (standard)

■ Package

- Code
SMini2-F5-B
- Pin Name
1: Cathode
2: Anode

■ Marking Symbol: 5A

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

| Parameter | Symbol | Rating | Unit |
|--|-----------|-------------|------|
| Repetitive peak reverse voltage | V_{RRM} | 800 | V |
| Non-repetitive peak reverse surge voltage | V_{RSM} | 800 | V |
| Forward current | I_F | 200 | mA |
| Non-repetitive peak forward surge current *1,2 | I_{FSM} | 1 | A |
| Junction temperature | T_j | -40 to +150 | °C |
| Storage temperature | T_{stg} | -40 to +150 | °C |

Note) *1: Mounted on an alumina PC board

*2: 50 Hz sine wave 1 cycle (Non-repetitive peak current)

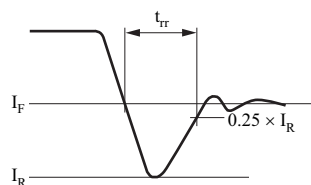
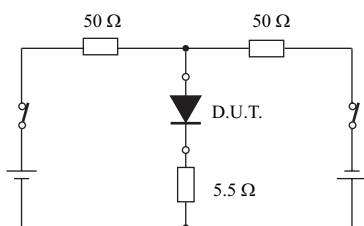
■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

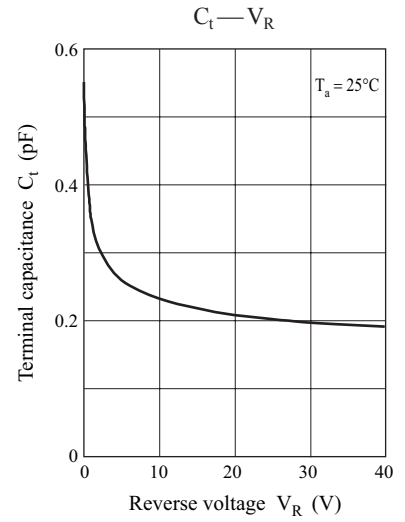
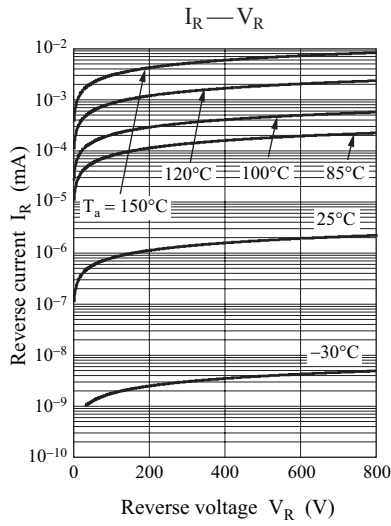
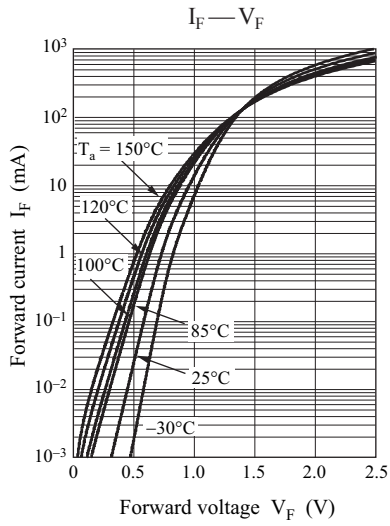
| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
|-------------------------|------------|---|-----|-----|-----|---------------|
| Forward voltage | V_F | $I_F = 200 \text{ mA}$ | | | 2.5 | V |
| Reverse current | I_{RRM1} | $V_{RRM} = 400 \text{ V}$ | | | 1 | μA |
| | I_{RRM2} | $V_{RRM} = 800 \text{ V}$ | | | 10 | |
| Terminal capacitance | C_t | $V_R = 0 \text{ V}, f = 1 \text{ MHz}$ | | 0.6 | | pF |
| Reverse recovery time * | t_{rr} | $I_F = 100 \text{ mA}, I_R = 200 \text{ mA},$ $I_{Tr} = 0.25 \times I_R$ | | 10 | 45 | ns |

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

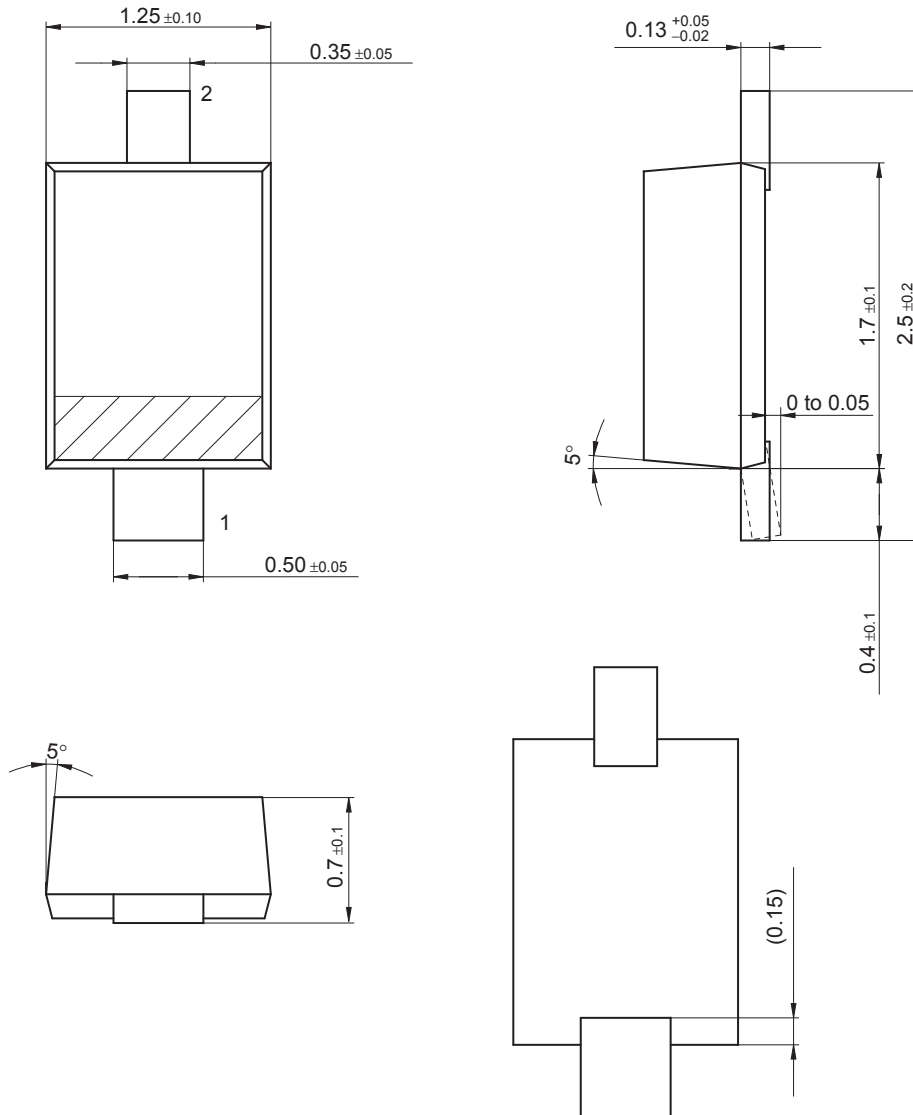
3. *: t_{rr} measurement circuit





SMini2-F5-B

Unit: mm



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